

BRIGHT LED ELECTRONICS CORP.

BPD-BQDA34

END- LOOK PACKAGE PIN PHOTO DIODE

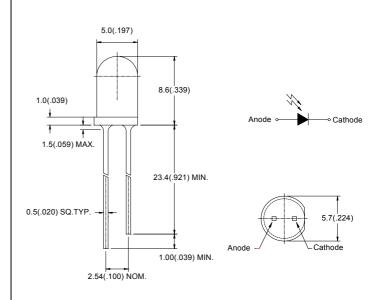
Features

- 1. Wide receiving angle
- 2. Linear response vs. irradiance
- 3. Fast switching time
- End-looking Package ideal for space limited applications
- 5. Lens Appearance: Black

Description

The BPD-BQDA34 device consists of a PIN silicon photodiode molded in a clear epoxy package which allows spectral response from visible to infrared light wavelengths. The wide receiving angle provides relatively even reception over a large area. The side-looking package is designed for easy PC board mounting. This photodiode is mechanically and spectrally matched to BRIGHT's GaAs and GaAlAs series of infrared emitting diodes.

●Package Dimensions:



NOTES:

- 1.All dimensions are in millimeters (inches).
- 2.Tolerance is ±0.25mm (0.01") unless otherwise specified.
- 3.Lead spacing is measured where the leads emerge from the package
- 4. Specifications are subject to change without notice

Absolute Maximum Ratings(Ta=25℃)

Parameter	Maximum Rating	Unit	
Power Dissipation	100	mW	
Reverse Breakdown Voltage	60V		
Operating Temperature	-45℃~+85℃		
Storage Temperature Range	-45℃~+100℃		
Lead Soldering Temperature	260°C for 5 seconds		



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■ Electrical Characteristics (TA=25°C unless otherwise noted)

PARAMETER	SYM BOL	MIN	TYP	MAX	UNITS	TEST CONDITIONS
Reverse Light Current	ΙL	ı	80	-	μA	V _R =5V.Ee=1mW/cm ²
Reverse Dark Current	I_D	-	-	30	nA	V _R =10V.Ee=0
Reverse Break down Voltage	$V_{(BR)}$	30	-	_	V	I _R =100μA
Forward Voltage	V _F	-	-	1.2	V	I _F =1mA
Total Capacitance	C _T	-	25	_	PF	V _R =20V.Ee=0,f=1.0MHZ
Rise Time/ Fall Time	tr/tf	-	5	_	ns	V _R =20V,λ=940nm.RL=50Ω

• Typical Optical-Electrical Characteristic Curves

